# **74LV132**Quad 2-input NAND Schmitt trigger Rev. 6 — 9 December 2015

**Product data sheet** 

### **General description** 1.

The 74LV132 is a low-voltage Si-gate CMOS device that is pin and function compatible with 74HC132 and 74HCT132.

The 74LV132 contains four 2-input NAND gates which accept standard input signals. They are capable of transforming slowly changing input signals into sharply defined, jitter-free output signals.

The gate switches at different points for positive and negative-going signals. The difference between the positive voltage V<sub>T+</sub> and the negative voltage V<sub>T-</sub> is defined as the input hysteresis voltage V<sub>H</sub>.

### **Features and benefits** 2.

- Wide operating voltage: 1.0 V to 5.5 V
- Optimized for low voltage applications: 1.0 V to 3.6 V
- Accepts TTL input levels between V<sub>CC</sub> = 2.7 V and V<sub>CC</sub> = 3.6 V
- Typical output ground bounce < 0.8 V at V<sub>CC</sub> = 3.3 V and T<sub>amb</sub> = 25 °C
- Typical HIGH-level output voltage (V<sub>OH</sub>) undershoot: > 2 V at V<sub>CC</sub> = 3.3 V and  $T_{amb} = 25 \, ^{\circ}C$
- ESD protection:
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V
- Multiple package options
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

### 3. **Applications**

- Wave and pulse shapers for highly noisy environments
- Astable multivibrators
- Monostable multivibrators



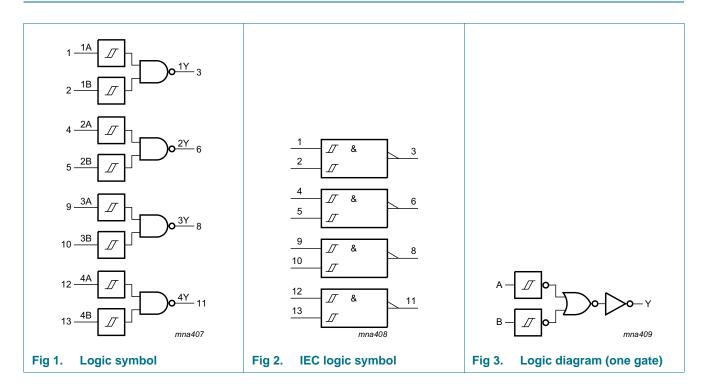
### **Quad 2-input NAND Schmitt trigger**

# 4. Ordering information

Table 1. Ordering information

| Type number | Package           | Package  |  |          |  |  |  |  |  |  |
|-------------|-------------------|----------|--|----------|--|--|--|--|--|--|
|             | Temperature range | Name     | Description  | Version  |  |  |  |  |  |  |
| 74LV132D    | –40 °C to +125 °C | SO14     | plastic small outline package; 14 leads;<br>body width 3.9 mm  | SOT108-1 |  |  |  |  |  |  |
| 74LV132DB   | –40 °C to +125 °C | SSOP14   | plastic shrink small outline package; 14 leads; body width 5.3 mm  | SOT337-1 |  |  |  |  |  |  |
| 74LV132PW   | -40 °C to +125 °C | TSSOP14  | plastic thin shrink small outline package; 14 leads; body width 4.4 mm   | SOT402-1 |  |  |  |  |  |  |
| 74LV132BQ   | -40 °C to +125 °C | DHVQFN14 | plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body $2.5\times3\times0.85$ mm | SOT762-1 |  |  |  |  |  |  |

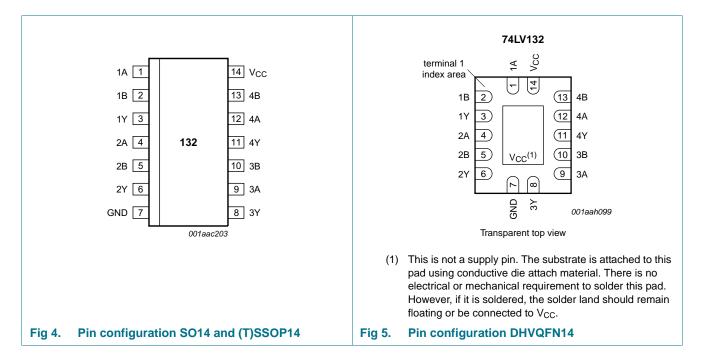
# 5. Functional diagram



### **Quad 2-input NAND Schmitt trigger**

# 6. Pinning information

### 6.1 Pinning



### 6.2 Pin description

Table 2. Pin description

| Symbol          | Pin          | Description    |
|-----------------|--------------|----------------|
| 1A to 4A        | 1, 4, 9, 12  | data input     |
| 1B to 4B        | 2, 5, 10, 13 | data input     |
| 1Y to 4Y        | 3, 6, 8, 11  | data output    |
| GND             | 7            | ground (0 V)   |
| V <sub>CC</sub> | 14           | supply voltage |

# 7. Functional description

Table 3. Function table

H = HIGH voltage level; L = LOW voltage level.

| Input | Output |    |
|-------|--------|----|
| nA    | nB     | nY |
| L     | L      | Н  |
| L     | Н      | Н  |
| Н     | L      | Н  |
| Н     | Н      | L  |

### **Quad 2-input NAND Schmitt trigger**

# 8. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol           | Parameter               | Conditions   |            | Min  | Max  | Unit |
|------------------|-------------------------|--|------------|------|------|------|
| V <sub>CC</sub>  | supply voltage          |  |            | -0.5 | +7.0 | V    |
| I <sub>IK</sub>  | input clamping current  | $V_{I} < -0.5 \text{ V or } V_{I} > V_{CC} + 0.5 \text{ V}$          | <u>[1]</u> | -    | ±20  | mA   |
| I <sub>OK</sub>  | output clamping current | $V_O < -0.5 \text{ V or } V_O > V_{CC} + 0.5 \text{ V}$              | <u>[1]</u> | -    | ±50  | mA   |
| Io               | output current          | $V_{O} = -0.5 \text{ V to } (V_{CC} + 0.5 \text{ V})$                |            | -    | ±25  | mA   |
| I <sub>CC</sub>  | supply current          |  |            | -    | 50   | mA   |
| I <sub>GND</sub> | ground current          |  |            | -50  | -    | mA   |
| T <sub>stg</sub> | storage temperature     |  |            | -65  | +150 | °C   |
| P <sub>tot</sub> | total power dissipation | $T_{amb} = -40  ^{\circ}\text{C} \text{ to } +125  ^{\circ}\text{C}$ |            |      |      |      |
|                  |                         | SO14 package   | [2]        | -    | 500  | mW   |
|                  |                         | (T)SSOP14 package  | [3]        | -    | 500  | mW   |
|                  |                         | DHVQFN14 package   | <u>[4]</u> | -    | 500  | mW   |

<sup>[1]</sup> The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

# 9. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V).

| Symbol           | Parameter           | Conditions | Min | Тур | Max             | Unit |
|------------------|---------------------|------------|-----|-----|-----------------|------|
| V <sub>CC</sub>  | supply voltage[1]   |            | 1.0 | 3.3 | 5.5             | V    |
| VI               | input voltage       |            | 0   | -   | V <sub>CC</sub> | V    |
| Vo               | output voltage      |            | 0   | -   | V <sub>CC</sub> | V    |
| T <sub>amb</sub> | ambient temperature |            | -40 | +25 | +125            | °C   |

<sup>[1]</sup> The static characteristics are guaranteed from  $V_{CC}$  = 1.2 V to  $V_{CC}$  = 5.5 V, but LV devices are guaranteed to function down to  $V_{CC}$  = 1.0 V (with input levels GND or  $V_{CC}$ ).

<sup>[2]</sup> Ptot derates linearly with 8 mW/K above 70 °C.

<sup>[3]</sup> Ptot derates linearly with 5.5 mW/K above 60 °C.

<sup>[4]</sup> Ptot derates linearly with 4.5 mW/K above 60 °C.

### **Quad 2-input NAND Schmitt trigger**

# 10. Static characteristics

Table 6. Static characteristics

Voltages are referenced to GND (ground = 0 V).

| Symbol           | Parameter                 | Conditions  | -40 | °C to +8 | 5 °C | -40 °C to | Unit |    |
|------------------|---------------------------|---|-----|----------|------|-----------|------|----|
|                  |                           |   | Min | Typ[1]   | Max  | Min       | Max  |    |
| V <sub>OH</sub>  | HIGH-level output voltage | $V_I = V_{T+}$ or $V_{T-}$  |     |          |      |           |      |    |
|                  |                           | $I_O = -100 \mu A; V_{CC} = 1.2 V$  | -   | 1.2      | -    | -         | -    | V  |
|                  |                           | $I_O = -100 \mu A; V_{CC} = 2.0 V$  | 1.8 | 2.0      | -    | 1.8       | -    | V  |
|                  |                           | $I_O = -100 \mu A; V_{CC} = 2.7 V$  | 2.5 | 2.7      | -    | 2.5       | -    | V  |
|                  |                           | $I_O = -100 \mu A; V_{CC} = 3.0 \text{ V}$                                    | 2.8 | 3.0      | -    | 2.8       | -    | V  |
|                  |                           | $I_O = -100 \mu A; V_{CC} = 4.5 V$  | 4.3 | 4.5      | -    | 4.3       | -    | V  |
|                  |                           | $I_{O} = -6 \text{ mA}; V_{CC} = 3.0 \text{ V}$                               | 2.4 | 2.82     | -    | 2.2       | -    | V  |
|                  |                           | $I_{O} = -12 \text{ mA}; V_{CC} = 4.5 \text{ V}$                              | 3.6 | 4.2      | -    | 3.5       | -    | V  |
| $V_{OL}$         | LOW-level output voltage  | $V_I = V_{T+}$ or $V_{T-}$  |     |          |      |           |      |    |
|                  |                           | $I_O = 100 \mu A; V_{CC} = 1.2 V$   | -   | 0        | -    | -         | -    | V  |
|                  |                           | $I_O = 100 \mu A; V_{CC} = 2.0 V$   | -   | 0        | 0.2  | -         | 0.2  | V  |
|                  |                           | $I_O = 100 \mu A; V_{CC} = 2.7 V$   | -   | 0        | 0.2  | -         | 0.2  | V  |
|                  |                           | $I_O = 100 \mu A; V_{CC} = 3.0 V$   | -   | 0        | 0.2  | -         | 0.2  | V  |
|                  |                           | $I_O = 100 \mu A; V_{CC} = 4.5 V$   | -   | 0        | 0.2  | -         | 0.2  | V  |
|                  |                           | $I_O = 6 \text{ mA}; V_{CC} = 3.0 \text{ V}$                                  | -   | 0.25     | 0.40 | -         | 0.50 | V  |
|                  |                           | $I_O = 12 \text{ mA}; V_{CC} = 4.5 \text{ V}$                                 | -   | 0.35     | 0.55 | -         | 0.65 | V  |
| l <sub>l</sub>   | input leakage current     | $V_I = V_{CC}$ or GND;<br>$V_{CC} = 5.5 \text{ V}$                            | -   | -        | 1.0  | -         | 1.0  | μΑ |
| I <sub>CC</sub>  | supply current            | $V_I = V_{CC}$ or GND; $I_O = 0$ A;<br>$V_{CC} = 5.5 \text{ V}$               | -   | -        | 20.0 | -         | 40   | μΑ |
| Δl <sub>CC</sub> | additional supply current | per input; $V_I = V_{CC} - 0.6 \text{ V}$ ; $V_{CC} = 2.7 \text{ V}$ to 3.6 V | -   | -        | 500  | -         | 850  | μΑ |
| Cı               | input capacitance         |   | -   | 3.5      | -    | -         | -    | pF |

<sup>[1]</sup> Typical values are measured at  $T_{amb}$  = 25 °C.

### **Quad 2-input NAND Schmitt trigger**

# 11. Dynamic characteristics

Table 7. Dynamic characteristics

GND = 0 V; For test circuit see Figure 7.

| Symbol          | Parameter                     | Conditions   |     | -40 °C to +85 °C |        | -40 °C to +125 °C |     | Unit |    |
|-----------------|-------------------------------|--|-----|------------------|--------|-------------------|-----|------|----|
|                 |                               |  |     | Min              | Typ[1] | Max               | Min | Max  |    |
| t <sub>pd</sub> | propagation delay             | nA, nB to nY; see Figure 6                                       | [2] |                  |        |                   |     |      |    |
|                 |                               | V <sub>CC</sub> = 1.2 V  |     | -                | 65     | -                 | -   | -    | ns |
|                 |                               | V <sub>CC</sub> = 2.0 V  |     | -                | 18     | 34                | -   | 43   | ns |
|                 |                               | V <sub>CC</sub> = 2.7 V  |     | -                | 15     | 24                | -   | 30   | ns |
|                 |                               | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V; } C_L = 15 \text{ pF}$ | [3] | -                | 10     | -                 | -   | -    | ns |
|                 |                               | V <sub>CC</sub> = 3.0 V to 3.6 V                                 | [3] | -                | 12     | 20                | -   | 25   | ns |
|                 |                               | V <sub>CC</sub> = 4.5 V to 5.5 V                                 | [3] | -                | 9.0    | 14                | -   | 17   | ns |
| C <sub>PD</sub> | power dissipation capacitance | $C_L$ = 50 pF; $f_i$ = 1 MHz;<br>$V_I$ = GND to $V_{CC}$         | [4] | -                | 24     | -                 | -   | -    | pF |

- [1] All typical values are measured at  $T_{amb} = 25$  °C.
- [2]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .
- [3] Typical values are measured at nominal supply voltage ( $V_{CC} = 3.3 \text{ V}$  and  $V_{CC} = 5.0 \text{ V}$ ).
- [4]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o) \text{ where:}$ 

 $f_i$  = input frequency in MHz,  $f_o$  = output frequency in MHz

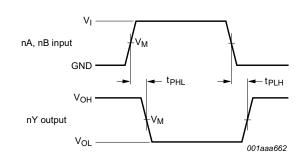
 $C_L$  = output load capacitance in pF

V<sub>CC</sub> = supply voltage in V

N = number of inputs switching

 $\Sigma (C_L \times V_{CC}{}^2 \times f_o)$  = sum of the outputs.

## 12. Waveforms



Measurement points are given in Table 8.

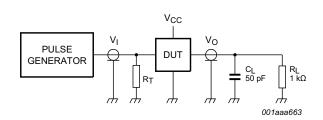
 $V_{\text{OL}}$  and  $V_{\text{OH}}$  are typical voltage output levels that occur with the output load.

Fig 6. The input (nA, nB) to output (nY) propagation delays

### **Quad 2-input NAND Schmitt trigger**

Table 8. Measurement points

| Supply voltage  | Input              | Output             |
|-----------------|--------------------|--------------------|
| V <sub>CC</sub> | V <sub>M</sub>     | V <sub>M</sub>     |
| < 2.7 V         | 0.5V <sub>CC</sub> | 0.5V <sub>CC</sub> |
| 2.7 V to 3.6 V  | 1.5 V              | 1.5 V              |
| ≥ 4.5 V         | 0.5V <sub>CC</sub> | 0.5V <sub>CC</sub> |



Test data is given in Table 9.

Definitions test circuit:

 $R_T$  = Termination resistance should be equal to output impedance  $Z_0$  of the pulse generator.

R<sub>L</sub> = Load resistance.

C<sub>L</sub> = Load capacitance including jig and probe capacitance.

Fig 7. Test circuit for measuring switching times

Table 9. Test data

| Supply voltage  | Input           |                                 |  |  |
|-----------------|-----------------|---------------------------------|--|--|
| V <sub>CC</sub> | V <sub>I</sub>  | t <sub>r</sub> , t <sub>f</sub> |  |  |
| < 2.7 V         | V <sub>CC</sub> | ≤ 2.5 ns                        |  |  |
| 2.7 V to 3.6 V  | 2.7 V           | ≤ 2.5 ns                        |  |  |
| ≥ 4.5 V         | V <sub>CC</sub> | ≤ 2.5 ns                        |  |  |

# 13. Transfer characteristics

Table 10. Transfer characteristics

GND = 0 V; For test circuit see Figure 7.

| Symbol   | Parameter         | Conditions              | −40 °C to +85 °C |        | –40 °C t | o +125 °C | Unit |   |
|----------|-------------------|-------------------------|------------------|--------|----------|-----------|------|---|
|          |                   |                         | Min              | Typ[1] | Max      | Min       | Max  |   |
| $V_{T+}$ | positive-going    | see Figure 6            |                  |        |          |           |      |   |
|          | threshold voltage | V <sub>CC</sub> = 1.2 V | -                | 0.70   | -        | -         | -    | V |
|          |                   | V <sub>CC</sub> = 2.0 V | 0.8              | 1.10   | 1.4      | 0.8       | 1.4  | V |
|          |                   | V <sub>CC</sub> = 2.7 V | 1.0              | 1.45   | 2.0      | 1.0       | 2.0  | V |
|          |                   | V <sub>CC</sub> = 3.0 V | 1.2              | 1.60   | 2.2      | 1.2       | 2.2  | V |
|          |                   | V <sub>CC</sub> = 3.6 V | 1.5              | 1.95   | 2.4      | 1.5       | 2.4  | V |
|          |                   | V <sub>CC</sub> = 4.5 V | 1.7              | 2.50   | 3.2      | 1.7       | 3.2  | V |
|          |                   | V <sub>CC</sub> = 5.5 V | 2.1              | 3.00   | 3.9      | 2.1       | 3.9  | V |

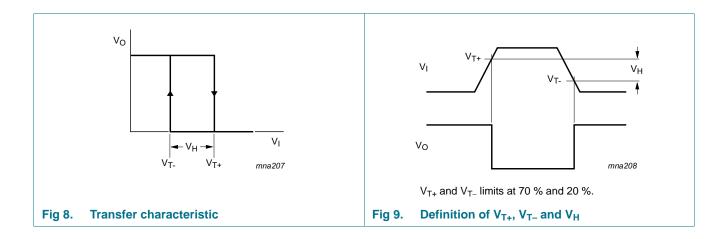
### **Quad 2-input NAND Schmitt trigger**

**Table 10. Transfer characteristics** ...continued GND = 0 V; For test circuit see <u>Figure 7</u>.

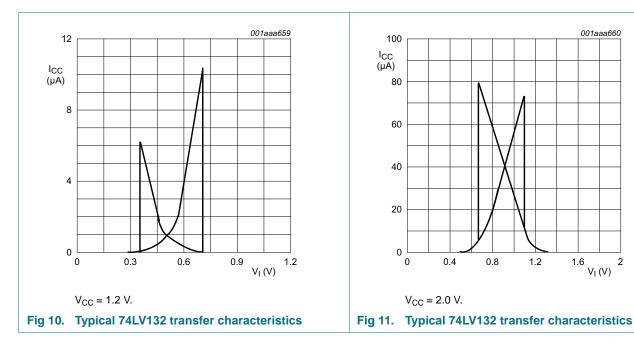
| Symbol   | Parameter          | Conditions  | -40 | °C to +85 | S °C | –40 °C t | o +125 °C | Unit |
|----------|--------------------|---|-----|-----------|------|----------|-----------|------|
|          |                    |   | Min | Typ[1]    | Max  | Min      | Max       |      |
| $V_{T-}$ | negative-going     | see Figure 6  |     |           |      |          |           |      |
|          | threshold voltage  | V <sub>CC</sub> = 1.2 V                                   | -   | 0.34      | -    | -        | -         | V    |
|          |                    | V <sub>CC</sub> = 2.0 V                                   | 0.3 | 0.65      | 0.9  | 0.3      | 0.9       | V    |
|          |                    | V <sub>CC</sub> = 2.7 V                                   | 0.4 | 0.90      | 1.4  | 0.4      | 1.4       | V    |
|          |                    | V <sub>CC</sub> = 3.0 V                                   | 0.6 | 1.05      | 1.5  | 0.6      | 1.5       | V    |
|          |                    | V <sub>CC</sub> = 3.6 V                                   | 0.8 | 1.30      | 1.8  | 0.8      | 1.8       | V    |
|          |                    | V <sub>CC</sub> = 4.5 V                                   | 0.9 | 1.60      | 2.0  | 0.9      | 2.0       | V    |
|          |                    | V <sub>CC</sub> = 5.5 V                                   | 1.2 | 2.00      | 2.6  | 1.2      | 2.6       | V    |
| $V_{H}$  | hysteresis voltage | (V <sub>T+</sub> – V <sub>T-</sub> ); see <u>Figure 6</u> |     |           |      |          |           |      |
|          |                    | V <sub>CC</sub> = 1.2 V                                   | -   | 0.3       | -    | -        | -         | V    |
|          |                    | V <sub>CC</sub> = 2.0 V                                   | 0.2 | 0.55      | 0.8  | 0.2      | 0.8       | V    |
|          |                    | V <sub>CC</sub> = 2.7 V                                   | 0.3 | 0.60      | 1.1  | 0.3      | 1.1       | V    |
|          |                    | V <sub>CC</sub> = 3.0 V                                   | 0.4 | 0.65      | 1.2  | 0.4      | 1.2       | V    |
|          |                    | V <sub>CC</sub> = 3.6 V                                   | 0.4 | 0.70      | 1.2  | 0.4      | 1.2       | V    |
|          |                    | V <sub>CC</sub> = 4.5 V                                   | 0.4 | 0.80      | 1.4  | 0.4      | 1.4       | V    |
|          |                    | V <sub>CC</sub> = 5.5 V                                   | 0.6 | 1.00      | 1.5  | 0.6      | 1.5       | V    |

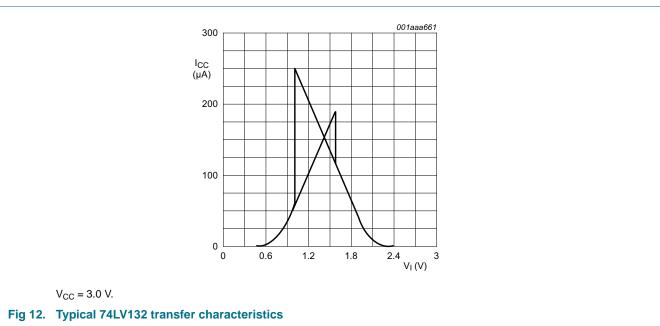
<sup>[1]</sup> All typical values are measured at  $T_{amb}$  = 25 °C.

### 14. Waveforms transfer characteristics



### **Quad 2-input NAND Schmitt trigger**



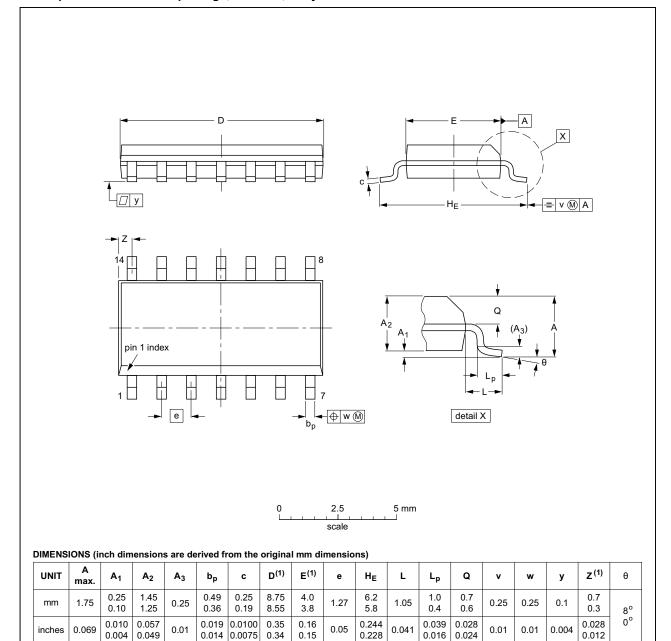


### **Quad 2-input NAND Schmitt trigger**

# 15. Package outline

### SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



### Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

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| IEC    | JEDEC  | JEITA | PROJECTION | 1330E DATE                      |
| 076E06 | MS-012 |       |            | <del>99-12-27</del><br>03-02-19 |
| _      |        |       |            | IEC JEDEC JEHA                  |

Fig 13. Package outline SOT108-1 (SO14)

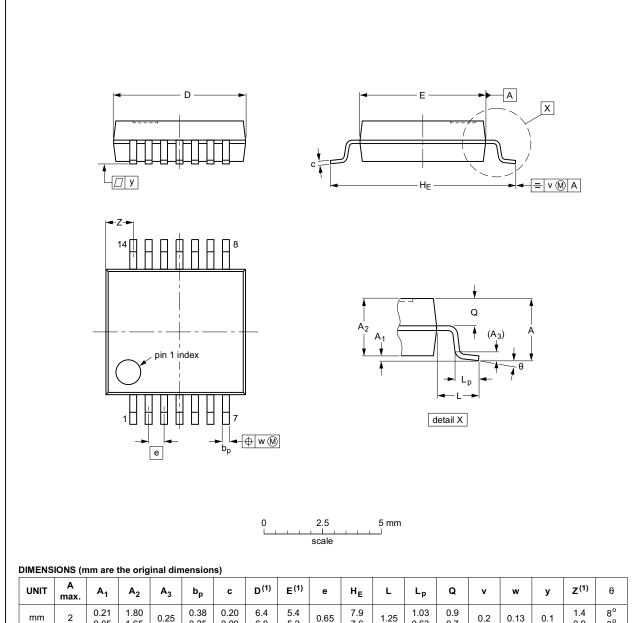
74LV132

74LV132 **NXP Semiconductors** 

### **Quad 2-input NAND Schmitt trigger**

SSOP14: plastic shrink small outline package; 14 leads; body width 5.3 mm

SOT337-1



| UNIT | A<br>max. | A <sub>1</sub> | A <sub>2</sub> | <b>A</b> <sub>3</sub> | b <sub>p</sub> | C            | D <sup>(1)</sup> | E <sup>(1)</sup> | е    | HE         | L    | Lp           | Q          | v   | w    | у   | Z <sup>(1)</sup> | θ        |
|------|-----------|----------------|----------------|-----------------------|----------------|--------------|------------------|------------------|------|------------|------|--------------|------------|-----|------|-----|------------------|----------|
| mm   | 2         | 0.21<br>0.05   | 1.80<br>1.65   | 0.25                  | 0.38<br>0.25   | 0.20<br>0.09 | 6.4<br>6.0       | 5.4<br>5.2       | 0.65 | 7.9<br>7.6 | 1.25 | 1.03<br>0.63 | 0.9<br>0.7 | 0.2 | 0.13 | 0.1 | 1.4<br>0.9       | 8°<br>0° |

### Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

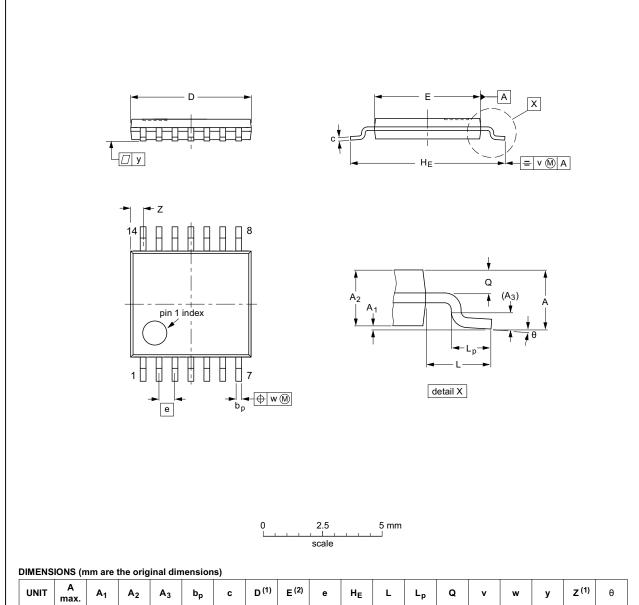
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| SOT337-1 |     | MO-150 |          |            |            | <del>99-12-27</del><br>03-02-19 |  |

Fig 14. Package outline SOT337-1 (SSOP14)

### **Quad 2-input NAND Schmitt trigger**

TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1



| UNIT | A<br>max. | A <sub>1</sub> | A <sub>2</sub> | <b>A</b> <sub>3</sub> | bp           | С          | D <sup>(1)</sup> | E (2)      | е    | HE         | L | Lp           | Q          | ٧   | w    | у   | Z <sup>(1)</sup> | θ        |
|------|-----------|----------------|----------------|-----------------------|--------------|------------|------------------|------------|------|------------|---|--------------|------------|-----|------|-----|------------------|----------|
| mm   | 1.1       | 0.15<br>0.05   | 0.95<br>0.80   | 0.25                  | 0.30<br>0.19 | 0.2<br>0.1 | 5.1<br>4.9       | 4.5<br>4.3 | 0.65 | 6.6<br>6.2 | 1 | 0.75<br>0.50 | 0.4<br>0.3 | 0.2 | 0.13 | 0.1 | 0.72<br>0.38     | 8°<br>0° |

### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

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| JEDEC  | JEITA  | PROJECTION | <b>V</b>                        |
| MO-153 |        |            | <del>99-12-27</del><br>03-02-18 |
|        | MO-153 | MO-153     | MO-153                          |

Fig 15. Package outline SOT402-1 (TSSOP14)

74I V132

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### **Quad 2-input NAND Schmitt trigger**

DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body  $2.5 \times 3 \times 0.85$  mm

SOT762-1

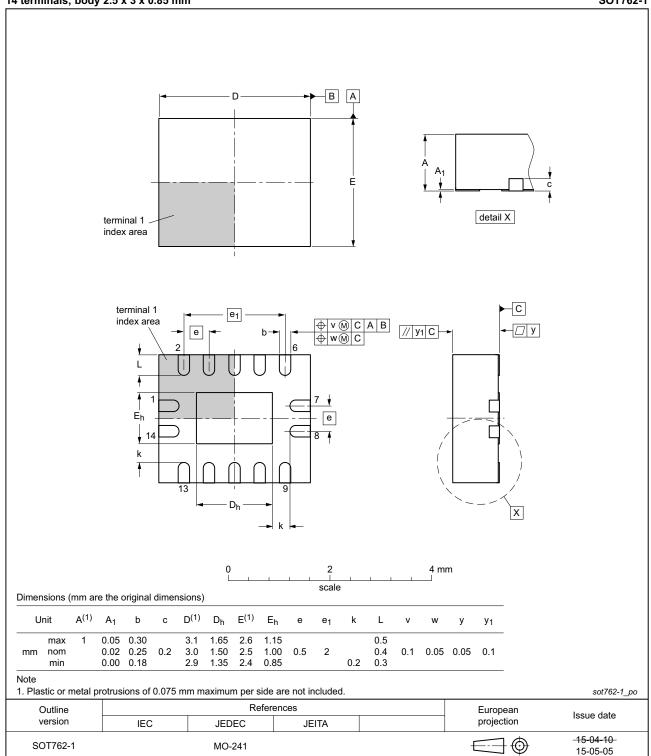


Fig 16. Package outline SOT762-1 (DHVQFN14)

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### **Quad 2-input NAND Schmitt trigger**

# 16. Abbreviations

### Table 11. Abbreviations

| Acronym | Description                             |
|---------|---|
| CMOS    | Complementary Metal Oxide Semiconductor |
| DUT     | Device Under Test                       |
| ESD     | ElectroStatic Discharge                 |
| НВМ     | Human Body Model                        |
| MM      | Machine Model                           |
| TTL     | Transistor-Transistor Logic             |

# 17. Revision history

### Table 12. Revision history

| Document ID    | Release date                    | Data sheet status               | Change notice         | Supersedes                   |
|----------------|---------------------------------|---------------------------------|-----------------------|------------------------------|
| 74LV132 v.6    | 20151209                        | Product data sheet              | -                     | 74LV132 v.5                  |
| Modifications: | Type number                     | 74LV132N (SOT27-1) remove       | ed.                   |                              |
| 74LV132 v.5    | 20090702                        | Product data sheet              | -                     | 74LV132 v.4                  |
| Modifications: | • <u>Table 6</u> : the changed. | conditions for HIGH-level outpu | it voltage and LOW-le | vel output voltage have been |
| 74LV132 v.4    | 20071112                        | Product data sheet              | -                     | 74LV132 v.3                  |
| 74LV132 v.3    | 20040415                        | Product specification           | -                     | 74LV132 v.2                  |
| 74LV132 v.2    | 19980428                        | Product specification           | -                     | 74LV132 v.1                  |
| 74LV132 v.1    | 19970204                        | Product specification           | -                     | -                            |

### **Quad 2-input NAND Schmitt trigger**

# 18. Legal information

### 18.1 Data sheet status

| Document status[1][2]          | Product status[3] | Definition  |
|--------------------------------|-------------------|---|
| Objective [short] data sheet   | Development       | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification     | This document contains data from the preliminary specification.                       |
| Product [short] data sheet     | Production        | This document contains the product specification.                                     |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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### **Quad 2-input NAND Schmitt trigger**

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